

## IGBT MODULE ( N series )

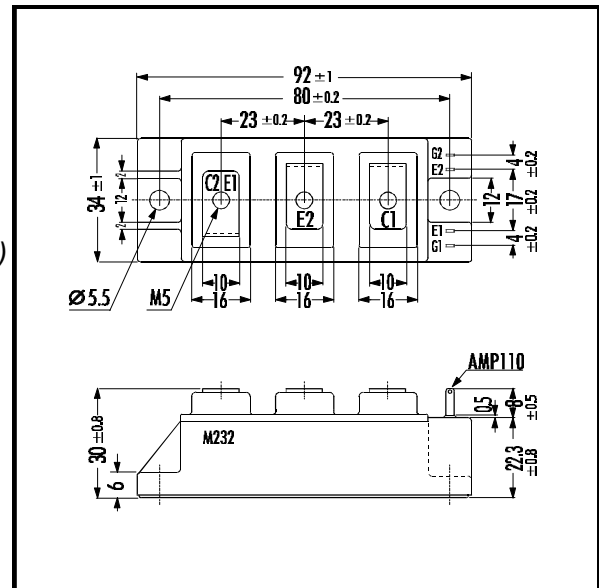
### ■ Features

- Square RBSOA
- Low Saturation Voltage
- Less Total Power Dissipation
- Improved FWD Characteristic
- Minimized Internal Stray Inductance
- Overcurrent Limiting Function (~3 Times Rated Current)

### ■ Applications

- High Power Switching
- A.C. Motor Controls
- D.C. Motor Controls
- Uninterruptible Power Supply

## ■ Outline Drawing



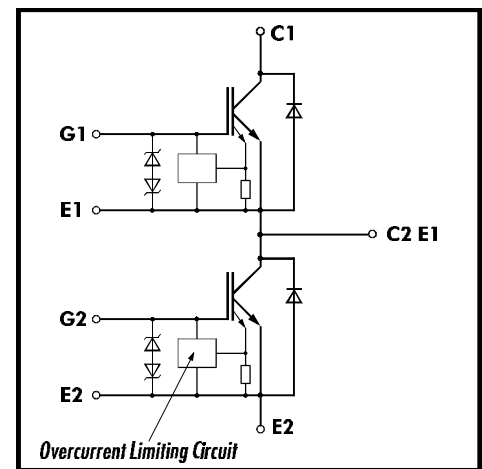
## ■ Maximum Ratings and Characteristics

### • Absolute Maximum Ratings ( T<sub>c</sub>=25°C )

Items	Symbols	Ratings	Units
Collector-Emitter Voltage	V <sub>CEs</sub>	600	V
Gate -Emitter Voltage	V <sub>GES</sub>	± 20	V
Collector Current	I <sub>C</sub>	100	A
	I <sub>C PULSE</sub>	200	
	-I <sub>C</sub>	100	
	-I <sub>C PULSE</sub>	200	
Max. Power Dissipation	P <sub>C</sub>	400	W
Operating Temperature	T <sub>i</sub>	+150	°C
Storage Temperature	T <sub>stg</sub>	-40 ~ +125	°C
Isolation Voltage	V <sub>is</sub>	2500	V
Screw Torque	Mounting *1	3.5	Nm
	Terminals *1	3.5	

Note: \*1:Recommendable Value; 2.5 ~ 3.5 Nm (M5)

## ■ Equivalent Circuit



### • Electrical Characteristics ( at T<sub>J</sub>=25°C )

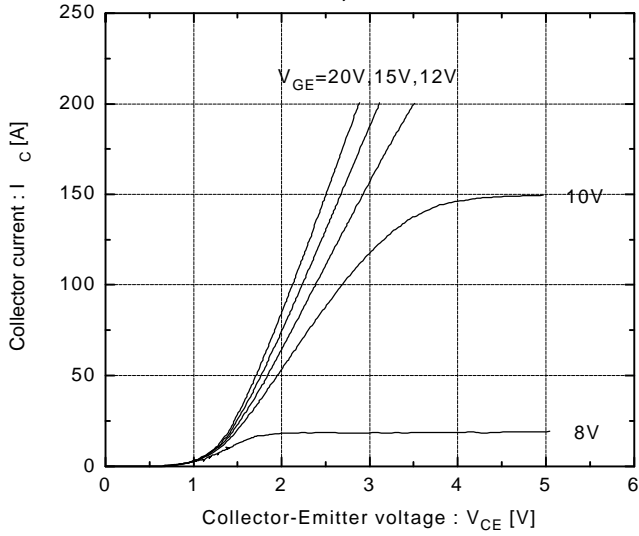
Items	Symbols	Test Conditions	Min.	Typ.	Max.	Units
Zero Gate Voltage Collector Current	I <sub>CEs</sub>	V <sub>GE</sub> =0V V <sub>CE</sub> =600V			1.0	mA
Gate-Emitter Leakage Current	I <sub>GES</sub>	V <sub>CE</sub> =0V V <sub>GE</sub> =± 20V			15	μA
Gate-Emitter Threshold Voltage	V <sub>GE(th)</sub>	V <sub>GE</sub> =20V I <sub>C</sub> =100mA	4.5		7.5	V
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	V <sub>GE</sub> =15V I <sub>C</sub> =100A			2.8	V
Input capacitance	C <sub>ies</sub>	V <sub>GE</sub> =0V V <sub>CE</sub> =10V f=1MHz		6600		pF
Output capacitance	C <sub>oes</sub>			1470		
Reverse Transfer capacitance	C <sub>res</sub>			670		
Turn-on Time	t <sub>ON</sub>	V <sub>CC</sub> =300V I <sub>C</sub> =100A		0.6	1.2	μs
	t <sub>r</sub>			0.2	0.6	
Turn-off Time	t <sub>OFF</sub>	V <sub>GE</sub> =± 15V R <sub>G</sub> =24Ω		0.6	1.0	
	t <sub>f</sub>			0.2	0.35	
Diode Forward On-Voltage	V <sub>F</sub>	I <sub>F</sub> =100A V <sub>GE</sub> =0V			3.0	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =100A			300	ns

### • Thermal Characteristics

Items	Symbols	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance	R <sub>th(f-c)</sub>	IGBT			0.31	°C/W
	R <sub>th(f-e)</sub>	Diode			0.70	
	R <sub>th(c-f)</sub>	With Thermal Compound		0.05		

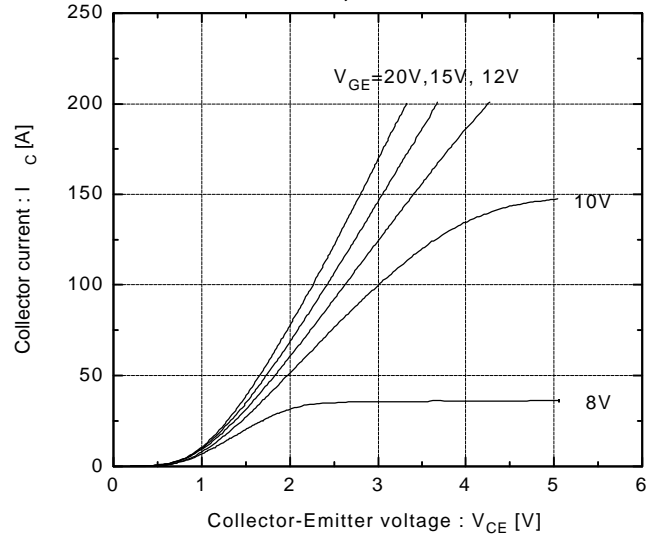
Collector current vs. Collector-Emmitter voltage

$T_j=25^\circ\text{C}$



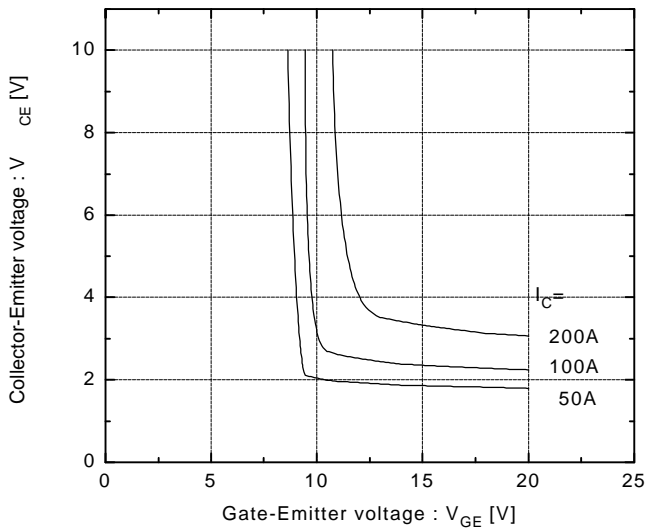
Collector current vs. Collector-Emmitter voltage

$T_j=125^\circ\text{C}$



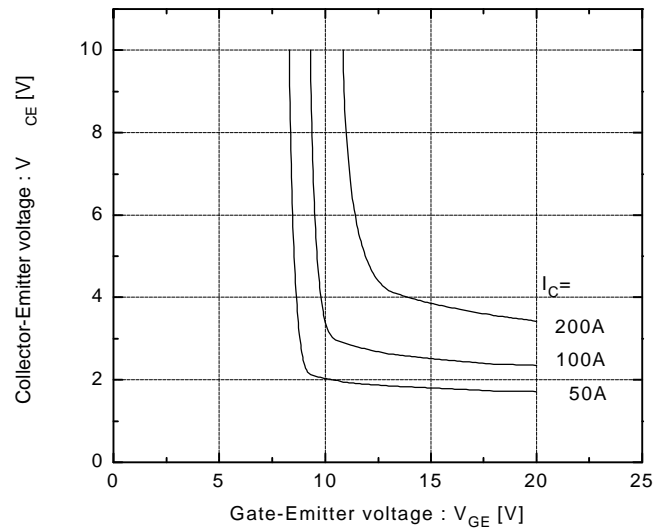
Collector-Emmitter vs. Gate-Emmitter voltage

$T_j=25^\circ\text{C}$

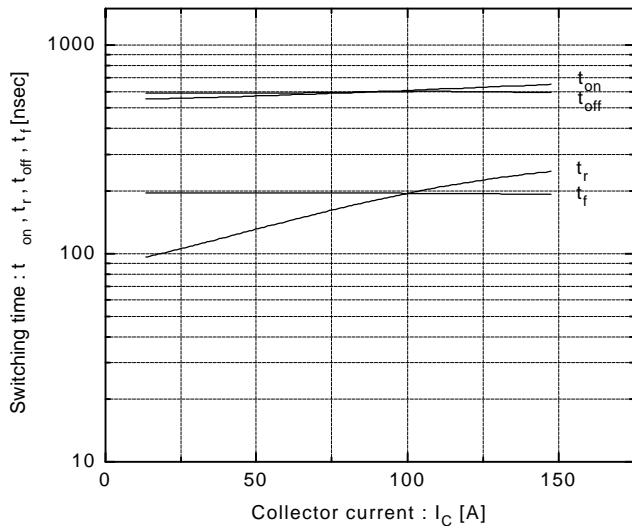


Collector-Emmitter vs. Gate-Emmitter voltage

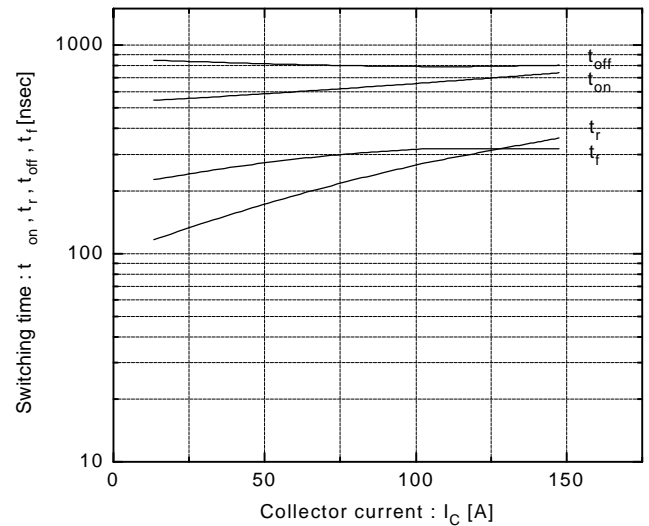
$T_j=125^\circ\text{C}$



Switching time vs. Collector current  
 $V_{CC}=300\text{V}, R_G=24\Omega, V_{GE}=\pm 15\text{V}, T_j=25^\circ\text{C}$

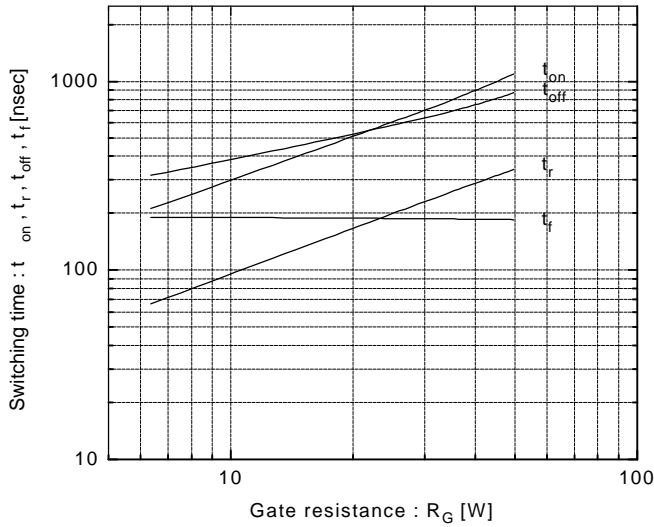


Switching time vs. Collector current  
 $V_{CC}=300\text{V}, R_G=24\Omega, V_{GE}=\pm 15\text{V}, T_j=125^\circ\text{C}$



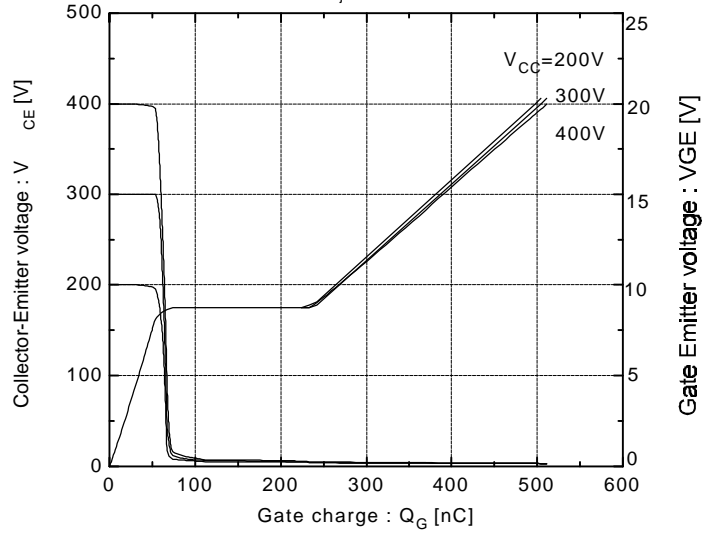
Switching time vs.  $R_G$

$V_{CC}=300V, I_C=100A, V_{GE}=\pm 15V, T_J=25^\circ C$



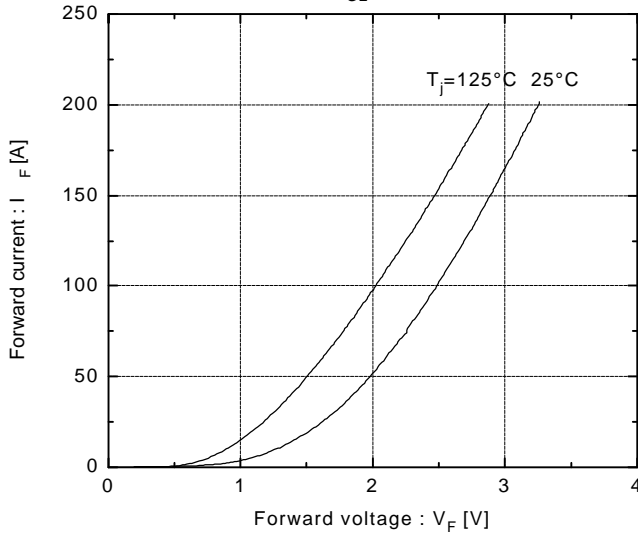
Dynamic input characteristics

$T_J=25^\circ C$



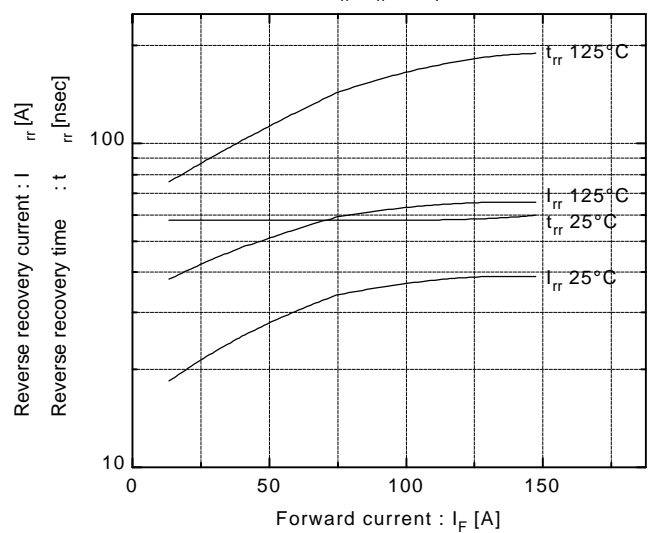
Forward current vs. Forward voltage

$V_{GE}=0V$

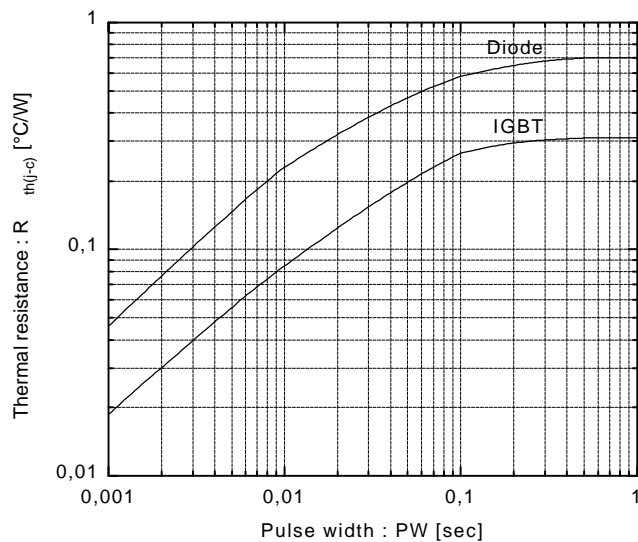


Reverse recovery characteristics

$t_{rr}, I_{rr}$  vs.  $I_F$

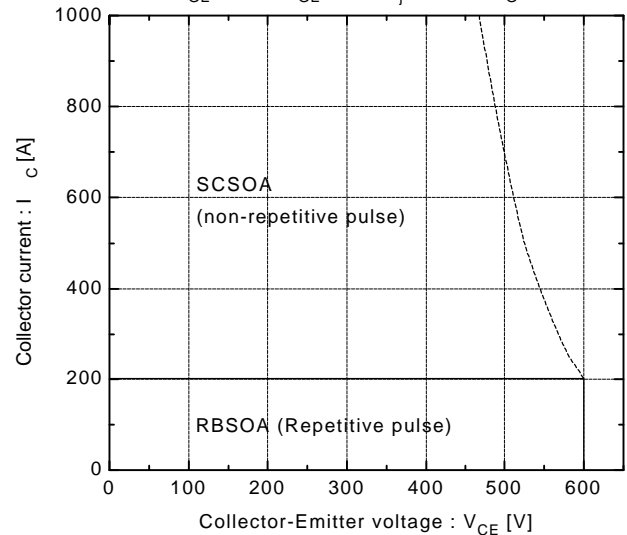


Transient thermal resistance



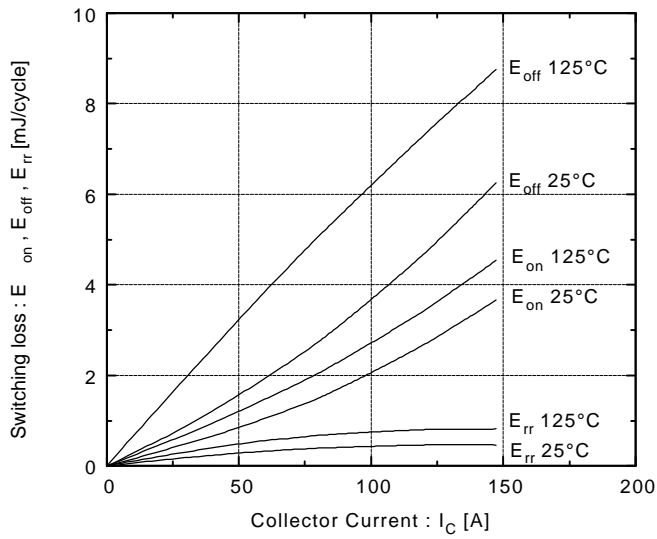
Reversed biased safe operating area

$+V_{GE}=15V, -V_{GE}\leq 15V, T_J\leq 125^\circ C, R_G\geq 24\Omega$



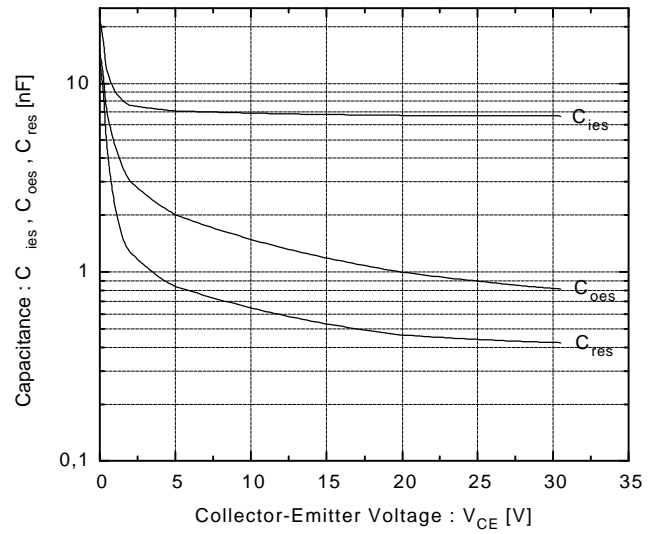
Switching loss vs. Collector current

$V_{CC}=300V, R_G=24\Omega, V_{GE}=\pm 15V$



Capacitance vs. Collector-Emitter voltage

$T_j=25^\circ C$



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